

### 5MHz to 6GHz Absorptive High Isolation SPDT Switch

## **Product Overview**

The RFSW6024 is a Silicon on Insulator (SOI) Single-Pole Double Throw (SPDT) switch designed for uses in cellular, 3G, LTE and other high-performance communication systems. It offers a high isolation, symmetric throw ports with excellent linearity and power handling capability. No DC blocking capacitors are necessary on the RF ports. The design is non-reflective as such the RF port 1 or RF port 2 is terminated in the non-throw state. The VEN enable pin allows the switch entering the "All OFF State". The RFSW6024 is 1.8V positive logic compatible.

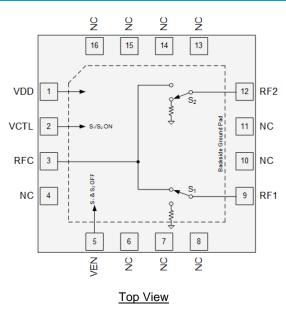


16 Pad 4 x 4 mm QFN Package

## **Key Features**

- 5-6000 MHz Operation
- Symmetric SPDT
- Non-Reflective RF1 & RF2 Ports
- No Blocking Capacitors Necessary Unless DC Voltage on RF line
- High Isolation: 60 dB at 2 GHz
- High Input IP3: +66 dBm
- +1.8 V Logic Compatible

# **Functional Block Diagram**



# **Applications**

- · Cellular, 3G, 4G, 5G Infrastructure
- WiBro, WiMax, LTE
- · Wireless Backhaul
- High Performance Communication Systems
- Test Equipment

# **Ordering Information**

Part No.	Description		
RFSW6024TR13	2,500 pieces on a 13" reel (standard)		
RFSW6024 PCK-410	5 MHz – 6GHz Evaluation Board		
KF3VV0024FCK-410	with 5-piece samples		



## 5 MHz to 6 GHz Absorptive High Isolation SPDT Switch

# **Absolute Maximum Ratings**

Parameter	Rating
Storage Temperature	−55 °C to +150 °C
RF Input Power, CW, 50 Ω, T=25 °C	+36 dBm
Device Voltage (VDD)	+6 V
Control Voltage (VCTL, VEN)	+6 V

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability.

## **Recommended Operating Conditions**

Parameter	Min	Тур	Max	Units
Device Voltage (VDD)	+2.5	+3.0	+5.5	V
TCASE	-40		+105	°C
Tj for >10 <sup>5</sup> hours MTTF			+125	°C

Electrical specifications are measured at specified test conditions. Specifications are not guaranteed over all recommended operating conditions.

## **Electrical Specifications**

Parameter	Conditions (1)	Min	Тур	Max	Units
Operational Frequency Range		5		6000	MHz
	0.3 GHz		0.55		dB
	1.0 GHz		0.60		dB
Insertion Loss (2)	2.0 GHz		0.75	1.00	dB
(RFC to RF1/RF2)	3.0 GHz		0.90		dB
	4.0 GHz		0.90		dB
	5.0 GHz		1.10		dB
	0.3 GHz		75		dB
	1.0 GHz		63		dB
Isolation	2.0 GHz	53	60		dB
(RFC to RF1/RF2)	3.0 GHz		60		dB
	4.0 GHz		60		dB
	5.0 GHz		48		dB
	0.3 GHz		80		dB
	1.0 GHz		70		dB
Isolation	2.0 GHz	53	60		dB
(RF1 to RF2)	3.0 GHz		53		dB
	4.0 GHz		48		dB
	5.0 GHz		49		dB
	0.3 GHz		28		dB
	1.0 GHz		27		dB
Return Loss	2.0 GHz		20		dB
(RF1/RF2 ON-State)	3.0 GHz		20		dB
	4.0 GHz		22		dB
	5.0 GHz		17		dB
	0.3 GHz		37		dB
	1.0 GHz		36		dB
Return Loss	2.0 GHz		30		dB
(RF1/RF2 OFF-State)	3.0 GHz		27		dB
	4.0 GHz		23		dB
	5.0 GHz		20		dB



## 5 MHz to 6 GHz Absorptive High Isolation SPDT Switch

# **Electrical Specifications (Continued)**

Parameter	Conditions (1)		Min	Тур	Max	Units
Operational Frequency Range			5		6000	MHz
Input ID2	1.0 GHz	+12 dBm input power per-tone,	55	65		dBm
Input IP3	2.0 GHz	1 MHz tone spacing	55	65		dBm
Input 0.1 dB Compression Power	1.0 GHz			36		dBm
Input 1 dB Compression Power	1.0 GHz	1.0 GHz		36		dBm
Setting Time	50% VCTL to optimum functionality			1.5	3.0	μs
Start-up Time	90% VDD to full functionality			25	50	μs
Constability Times	50% contr	50% control to 10/90% RF		250		ns
Switching Time	50% contr	ol to 2/98% RF		360	600	ns
Supply Current (IDD)	VDD 5.0V			140	200	μA
Control Current, (I <sub>CTL</sub> , I <sub>EN</sub> )	VCTL 5.0V			0.5	5.0	μA
Low Control Voltage (VCTL)	4.0.1/1.5.5	4014			0.63	V
High Control Voltage (VCTL)	1.8 V Logi	c compatible	1.1		VDD	V

#### Notes:

- 1. Test conditions unless otherwise noted: VDD = +5.0 V, VCTL = 0/+5.0 V, Temp = +25 °C, 50 Ω system, RF ports DC Voltage 0V
- 2. PCB trace loss deducted.

# Maximum Operating Power at +85C, ≥300 MHz CW

Input Port	State	VEN	Power	Thermal Resistance, $\theta_{jc}$
RFC, RF1 or RF2	ON	Low	33.0 dBm <sup>(1)</sup>	97 °C/W <sup>(2)</sup>
RFC	Both OFF & RFC Reflective	High	31.3 dBm	N/A
RF1 or RF2	OFF & Terminated (5)	Low or High	26.0 dBm	100 °C/W
RF1 and RF2	Both OFF & Terminated (5)	High	27.8 dBm <sup>(3)</sup>	65 °C/W

#### Notes:

- 1. Load VSWR  $\leq$  3:1; for higher load VSWR, the maximum Input power reduced to +30.5 dBm
- 2. Apply to resistive loss from the insertion loss not including mismatch loss
- 3. Total power on both RF1 and RF2 ports being driven simultaneously
- 4. For < 300 MHz, it is recommended to operate at least 4 dB below Input 1 dB Compression Power
- 5. Internally terminated

#### **Truth Table**

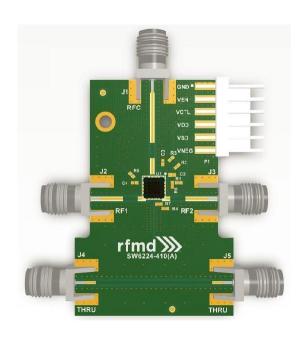
Control Input		Signal Path State		
VCTL	VEN	RFC   RF1	RFC ≒ RF2	
0	0	OFF	ON	
1	0	ON	OFF	
0	1	OFF	OFF	
1	1	OFF	OFF	

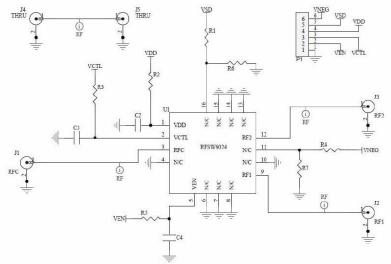
#### Notes:

"0" = 0 V to 0.63 V; "1" = 1.1 V to VDD; VDD = 2.5 to 5.5 V must be applied for all valid states



## 5 MHz to 6 GHz Evaluation Board - RFSW6024PCK-410





## Bill of Material - RFSW6024PCK-410

Reference Des.	Value	Description	Manuf.	Part Number
-	-	Printed Circuit Board	Qorvo	RFSW6224-410(A)
U1	-	SOI, High Isolation SPDT RF switch	Qorvo	RFSW6024
C2, C3, C4 <sup>(1)</sup>	100 pF	CAP, 100 pF, 5%, 50V, C0G, 0402	Taiyo Yuden	RM UMK105 CG101JV-F
R2, R3, R5, R6, R7	0 Ω	RES, 0 Ω, 50 Ω Max. Lead Free, 0402	KOA	RK73Z1ETTP
J1, J2, J3, J4, J5	SMA	CONN, SMA, EL, Mini FLT 0.068", SPE-000303	Aliner	20-001CF-T
P1	-	CONN, HDR, ST, PLRZD, 6-Pin, 0.100"	AMP	640454-6

Note:

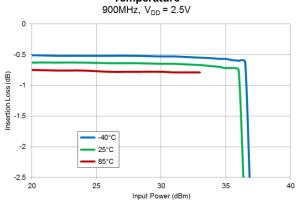
<sup>1.</sup> Optional



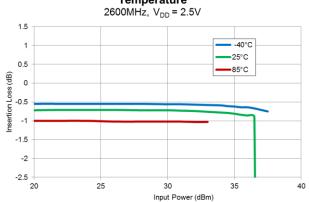
## Performance Plots - RFSW6024PCK-410

Test conditions unless otherwise noted: VDD = +3.0 V, Temp.=+25 °C

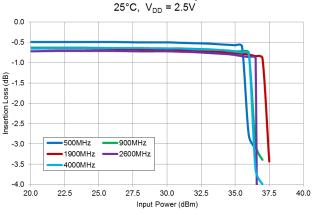
#### Insertion Loss versus RF Power over Temperature



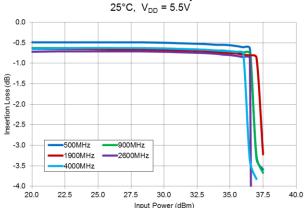
# Insertion Loss versus RF Power Over Temperature



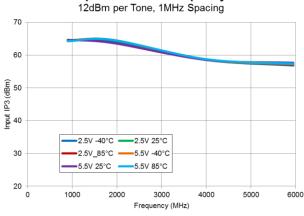
### Insertion Loss versus Input Power



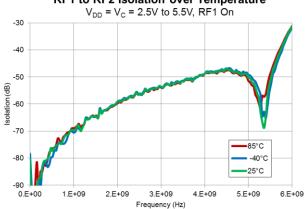
#### Insertion Loss versus Input Power



## Input IP3 versus Frequency



#### RF1 to RF2 Isolation over Temperature



6.E+09



## Performance Plots - RFSW6024PCK-410 (Continued 1)

Test conditions unless otherwise noted: VDD = +3.0 V, Temp.=+25 °C

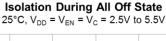
## RFC to RF2 Isolation over Temperature

 $V_{DD} = V_{C} = 2.5V$  to 5.5V, RF1 On 0 -10 25°C -20 •85°C -30 -40 -50 -60 -70 -80 -90 -100 0.E+00 1.E+09 2.E+09 5.E+09 6.E+09 Frequency (Hz)

#### RF1 to RF2 Isolation $25^{\circ}$ C, $V_{DD} = 2.5V$ to 5.5V0 -10 Vc Low -20 Vc High -30 -40 Isolation (dB) -50 -60 -70 -80 -90

## **Isolation versus Frequency**

25°C,  $V_{DD}$  = 2.5V to 5.5V,  $V_{C}$  = 0V/ $V_{DD}$ 0 -10 RFC to RF2 -20 RFC to RF1 -30 RF1 to RF2 -40 Isolation (dB) -50 -60 -70 -80 -90 0.E+00 1.E+09 2.E+09 3.E+09 4.E+09 5.E+09 6.E+09



3.E+09

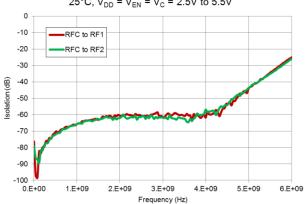
Frequency (Hz)

-100

0.E+00

1.E+09

2.E+09

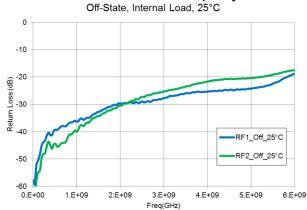


## **Return Loss versus Frequency**

Frequency (Hz)

On-State, 25°C 0 RF1\_25°C -5 RF2 25°C -10 RFC 25°C Return L -20 -25 -30 -35 Frequency (GHz)

#### Return Loss versus Frequency

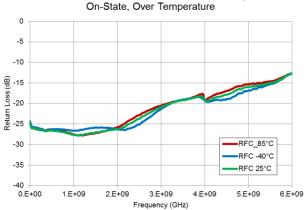




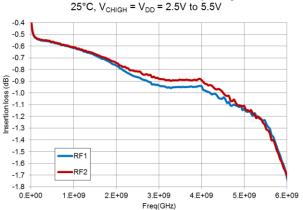
## Performance Plots - RFSW6024PCK-410 (Continued 2)

Test conditions unless otherwise noted: VDD = +3.0 V, Temp.=+25 °C

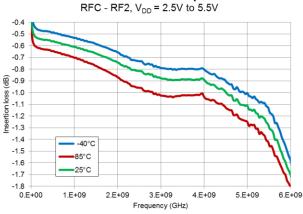
#### RFC Return Loss versus Frequency



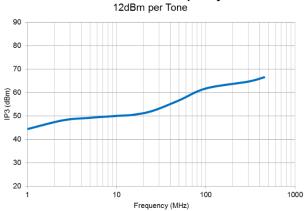
## Insertion Loss versus Frequency



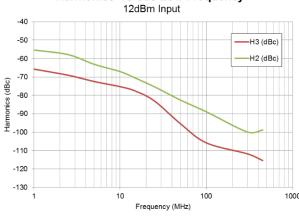
## Insertion Loss over Temperature



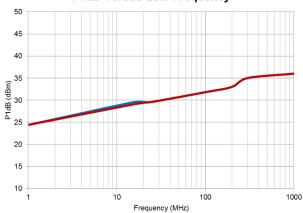
#### **IP3 versus Low Frequency**



## Harmonics versus Low Frequency



### P1dB versus Low Frequency

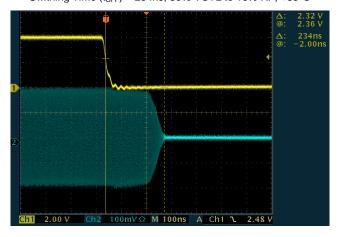




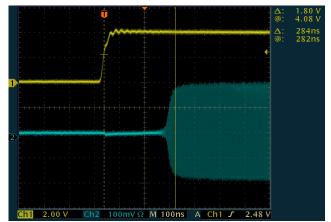


# **Switching Time Plots**

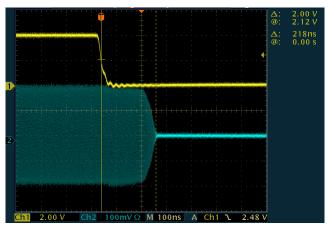
Swithing Time ( $t_{OFF}$ ) = 234ns, 50% VCTL to 10% RF, +85°C



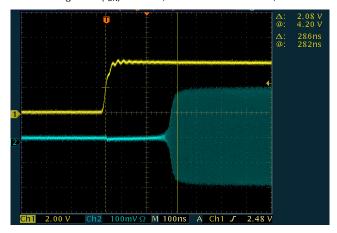
Swithing Time ( $t_{ON}$ ) = 284ns, 50% VCTL to 90% RF, +85°C



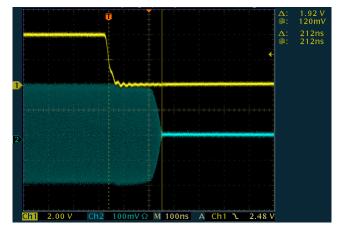
Swithing Time ( $t_{OFF}$ ) = 218ns, 50% VCTL to 10% RF, +25°C



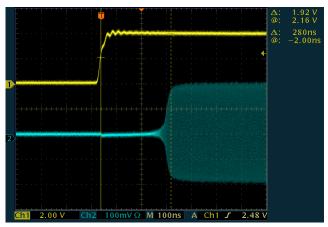
Swithing Time ( $t_{ON}$ ) = 286ns, 50% VCTL to 90% RF, +25°C



Swithing Time ( $t_{OFF}$ ) = 212ns, 50% VCTL to 10% RF, -40°C

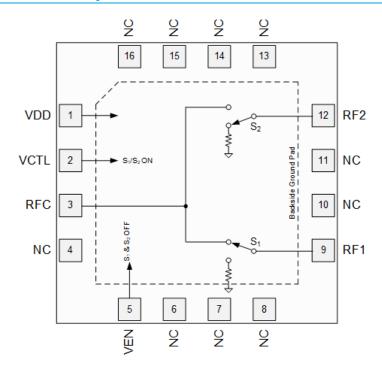


Swithing Time ( $t_{ON}$ ) = 280ns, 50% VCTL to 90% RF, -40°C





# **Pad Configuration and Description**



Top View

Pad No.	Label	Description
1	VDD	DC Supply Voltage Input
2	VCTL	Logic Control Input, Logic High/Low sets the switch RFC-RF1/RF2 to "ON" state
3	RFC	RF Common Port, DC blocking capacitor required if > 0.5 V external voltage is present
4, 8, 13, 16	NC	No Internal Connection, External connection to PCB Ground Recommended to maximize isolation
5	VEN	Logic Control Input, Logic High sets the switch both RF1 and RF2 to "OFF" state
6, 7, 10, 11, 14, 15	NC	Ground or No Connection, External connection to PCB Ground Recommended to maximize isolation
9	RF1	RF Port 1, DC blocking capacitor required if > 0.5 V external voltage is present
12	RF2	RF Port 2, DC blocking capacitor required if > 0.5 V external voltage is present
Backside Paddle	GND	RF and DC ground. Must be soldered on PCB ground plane over a bed of via holes to minimize inductance and thermal resistance

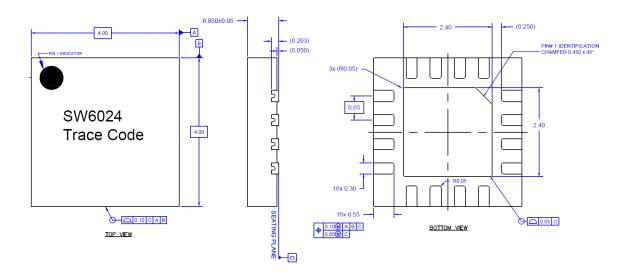




## **Package Marking and Dimensions**

Marking: Part Number - SW6024

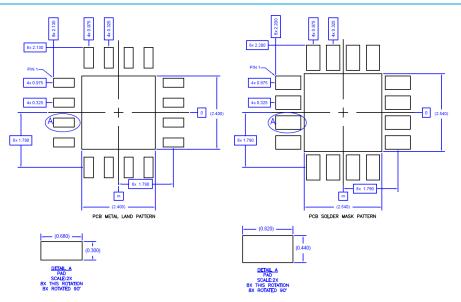
Trace Code - Assigned by subcontractor



#### Notes

- 1. All dimensions are in millimeters. Angles are in degrees.
- 2. The terminal #1 identifier and terminal numbering conform to JESD 95-1 SPP-012.
- 3. Contact plating: NiPdAu

## **PCB Mounting Pattern**

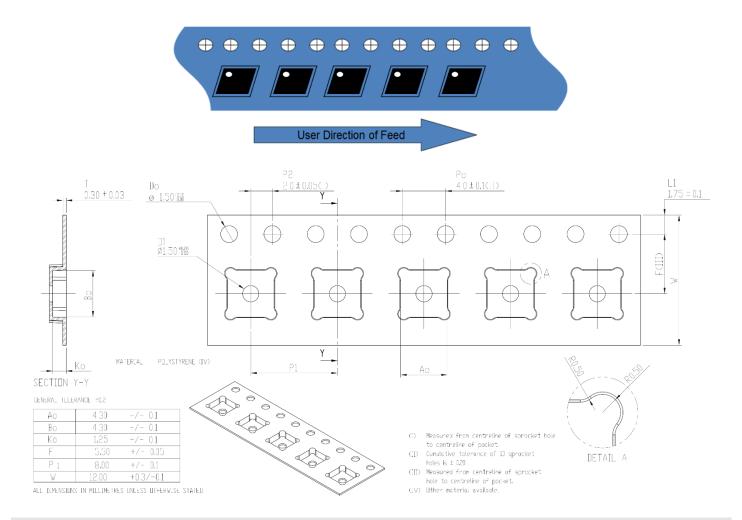


#### Notes:

- 1. All dimensions are in millimeters. Angles are in degrees.
- 2. Use 1 oz. copper minimum for top and bottom layer metal.
- 3. Via holes are required under the backside paddle of this device for proper RF/DC grounding and thermal dissipation. We recommend a 0.35mm (#80/.0135") diameter bit for drilling via holes and a final plated thru diameter of 0.25 mm (0.01").
- 4. Ensure good package backside paddle solder attach for reliable operation and best electrical performance.



# **Tape and Reel Information – Carrier and Cover Tape Dimensions**

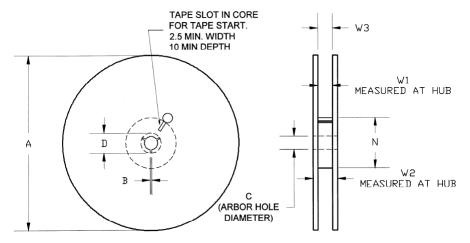


Feature	Measure	Symbol	Size (in)	Size (mm)
	Length	A0	0.169	4.30
Covity	Width	B0	0.169	4.30
Cavity	Depth	K0	0.049	1.25
	Pitch	P1	0.315	8.00
Centerline Distance	Cavity to Perforation - Length Direction	P2	0.079	2.00
Centenine Distance	Cavity to Perforation - Width Direction	F	0.217	5.50
Cover Tape Width (Reference Only)		С	0.362	9.20
Carrier Tape	Width	W	0.472	12.0



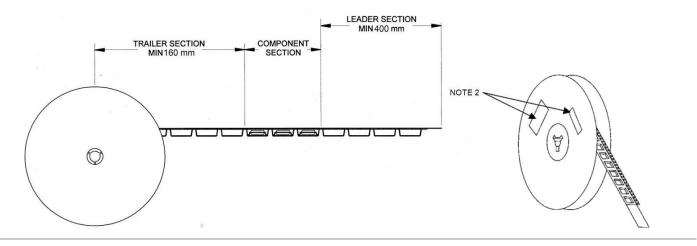
## **Tape and Reel Information – Reel Dimensions**

Standard T/R size = 2,500 pieces on a 13" reel.



Feature	Measure	Symbol	Size (in)	Size (mm)
	Diameter	Α	12.992	330.0
Flange	Thickness	W2	0.717	18.2
5	Space Between Flange	W1	0.504	12.8
	Outer Diameter	N	4.016	102.0
Llub	Arbor Hole Diameter	С	0.512	13.0
Hub Key S	Key Slit Width	В	0.079	2.0
	Key Slit Diameter	D	0.787	20.0

# Tape and Reel Information – Tape Length and Label Placement



#### Notes

- 1. Empty part cavities at the trailing and leading ends are sealed with cover tape. See EIA 481-1-A.
- 2. Labels are placed on the flange opposite the sprockets in the carrier tape.



## 5 MHz to 6 GHz Absorptive High Isolation SPDT Switch

## **Handling Precautions**

Parameter	Rating	Standard
ESD – Human Body Model (HBM)	Class 2	ESDA / JEDEC JS-001-2012
ESD – Charged Device Model (CDM)	Class C3	JEDEC JESD22-C101F
MSL – Moisture Sensitivity Level	Level 1	IPC/JEDEC J-STD-020



Caution! ESD-Sensitive Device

## **Solderability**

Compatible with both lead-free (260°C max. reflow temp.) and tin/lead (245°C max. reflow temp.) soldering processes. Solder profiles available upon request.

Contact plating: NiPdAu

## **RoHS Compliance**

This part is compliant with 2011/65/EU RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment) as amended by Directive 2015/863/EU.

This product also has the following attributes:

- · Lead Free
- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A (C<sub>15</sub>H<sub>12</sub>Br<sub>4</sub>O<sub>2</sub>) Free
- SVHC Free
- PFOS Free



### Contact Information

For the latest specifications, additional product information, worldwide sales and distribution locations:

Web: <u>www.qorvo.com</u>
Tel: 1-844-890-8163

Email: customer.support@gorvo.com

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